High Speed, High Power, Hermetic Infrared Emitting Diode



OP224K

Features:

- Hermetically sealed package
- Mechanically and spectrally matched to other OPTEK devices
- Designed for direct mount to PCBoard
- High Modulation Bandwidth
- High Irradiance Power



Description:

The **OP224K** device is an 875 nm gallium aluminum arsenide infrared emitting diode (GaAlAs), mounted in a hermetically sealed "pill" package with an enhanced temperature range and a narrow irradiance pattern that provides high on-axis intensity for excellent coupling efficiency. These devices offer significantly higher power output than GaAs at equivalent drive currents and have a wavelength that is matched to silicon's peak response. Their small package size permits high device density mounting.

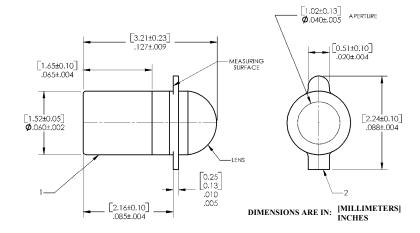
All these LEDs are mechanically and spectrally matched to the OP300 series, OP600 series and OP640 series devices.

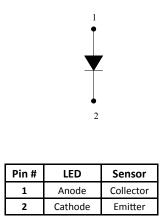
<u>Please refer to Application Bulletins 208 and 210 for additional design information and reliability (degradation) data, and to Application Bulletin 202 for pill-type soldering to PCBoard.</u>

Applications:

- Non-contact reflective object sensor
- Assembly line automation
- Machine automation
- Machine safety
- End of travel sensor
- Door sensor
- Encoders
- Free Air Data Transmissions

| Ordering Information | | | | | | |
|----------------------|------------------------|-------------|--|--|--|--|
| Part Number | LED Peak Wavelength | ength Angle | | | | |
| OP224k | 875nm | | | | | |







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Electrical Specifications

| osolute Maximum Ratings (T _A = 25° C unless otherwise noted) | | | | |
|---|--------------------------|--|--|--|
| Storage Temperature Range | -65°C to +150°C | | | |
| Operating Temperature Range | -65°C to +125°C | | | |
| Reverse Voltage | 2.0 V | | | |
| Continuous Forward Current | 100 mA | | | |
| Peak Forward Current (2µs pulse with 0.1% duty cycle) | 1.0 A | | | |
| Lead Soldering Temperature [1/16 inch (1.6 mm) from case for 5 seconds with soldering iron] | 260° C ⁽¹⁾⁽²⁾ | | | |
| Power Dissipation | 150 mW ⁽³ | | | |

| Electrical Characteristics (T _A = 25° C unless otherwise noted) | | | | | | | | | |
|--|--|------|-------|------|--------|---|--|--|--|
| SYMBOL | PARAMETER | MIN | TYP | MAX | UNITS | TEST CONDITIONS | | | |
| Input Did | Input Diode | | | | | | | | |
| E _{E (APT)} (3) | Apertured Radiant Incidence OP224K | 5.00 | - | - | mW/cm² | I _F = 50 mA ⁽⁴⁾ | | | |
| V _F | Forward Voltage OP224K | - | - | 2.00 | V | I _F = 50 mA | | | |
| I_R | Reverse Current | - | - | 100 | μA | V _R = 2.0 V | | | |
| λ_{P} | Wavelength at Peak Emission OP224K | - | 875 | - | nm | I _F = 20 mA | | | |
| В | Spectral Bandwidth between Half Power Points OP224K | - | 45 | - | nm | I _F = 20 mA | | | |
| $\Delta \lambda_{P}/\Delta T$ | Spectral Shift with Temperature OP224 | - | +0.18 | - | nm/°C | I _F = Constant | | | |
| $\theta_{\sf HP}$ | Emission Angle at Half Power Points | - | 24 | - | Degree | I _F = 50 mA | | | |
| t _r | Output Rise Time OP224K | - | 25 | - | ns | I _{F(PK)} =50 mA, PW=10 μs, and D.C.=10.0% | | | |
| t _f | Output Fall Time OP224K | - | 25 | - | ns | 15(βκ) - 30 111/7, τ νν - 10 μ5, απα υ.υ 10.0 % | | | |

Notes:

- 1. Refer to Application Bulletin 202 which reviews proper soldering techniques for pill-type devices.
- 2. No clean or low solids. RMA flux is recommended. Duration can be extended to 10 seconds maximum when flow soldering.
- 3. Derate linearly 1.50 mW/° C above 25° C.
- 4. E_{E(APT)} is a measurement using a 0.031" (0.787 mm) diameter apertured sensor placed 0.50" (12.7 mm) from the measuring surface. E_{E(APT)} is not necessarily uniform within the measured area.

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Performance

